

ON Semiconductor®

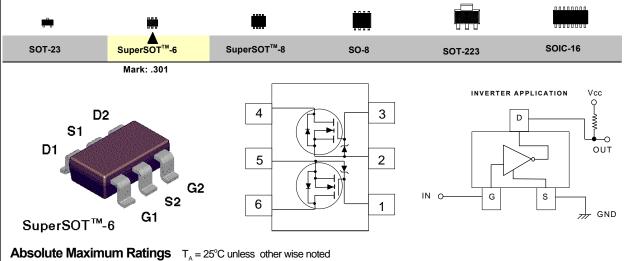
FDC6301N Dual N-Channel , Digital FET

General Description

These dual N-Channel logic level enhancement mode field effect transistors are produced using ON Semiconductor 's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, these N-Channel FET's can replace several digital transistors, with a variety of bias resistors.

Features

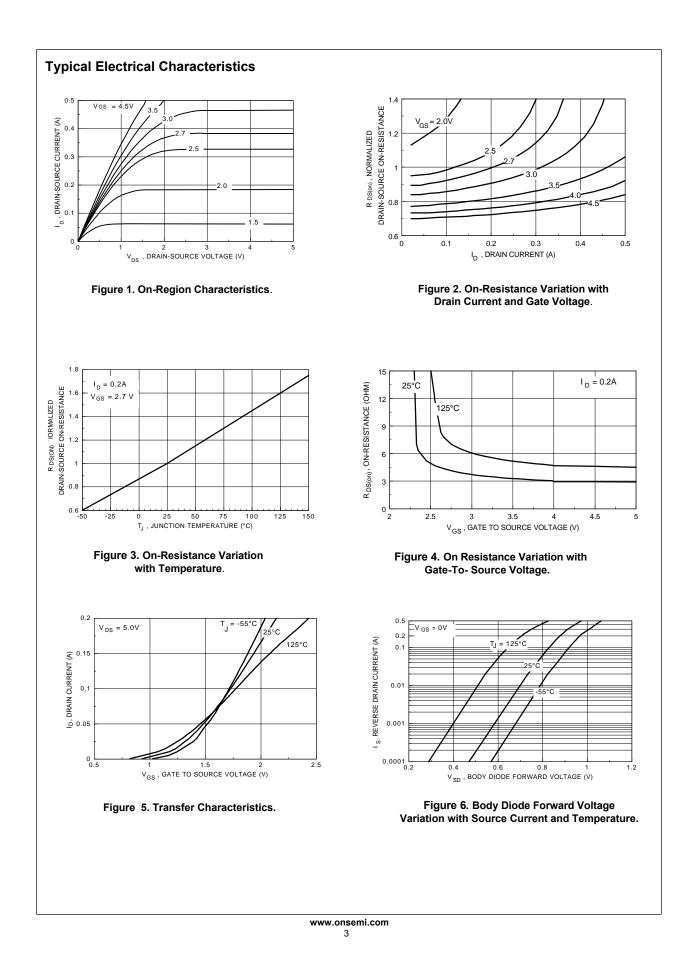
- $\label{eq:continuous} \begin{array}{c} \bullet & 25 \mbox{ V}, \mbox{ 0.22 A continuous}, \mbox{ 0.5 A Peak}. \\ & R_{_{DS(ON)}} = 5 \ \Omega \ @ \ V_{_{GS}} = 2.7 \ V \\ & R_{_{DS(ON)}} = 4 \ \Omega \ @ \ V_{_{GS}} = 4.5 \ V. \end{array}$
- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1.5V.
- Gate-Source Zener for ESD ruggedness.
 >6kV Human Body Model.

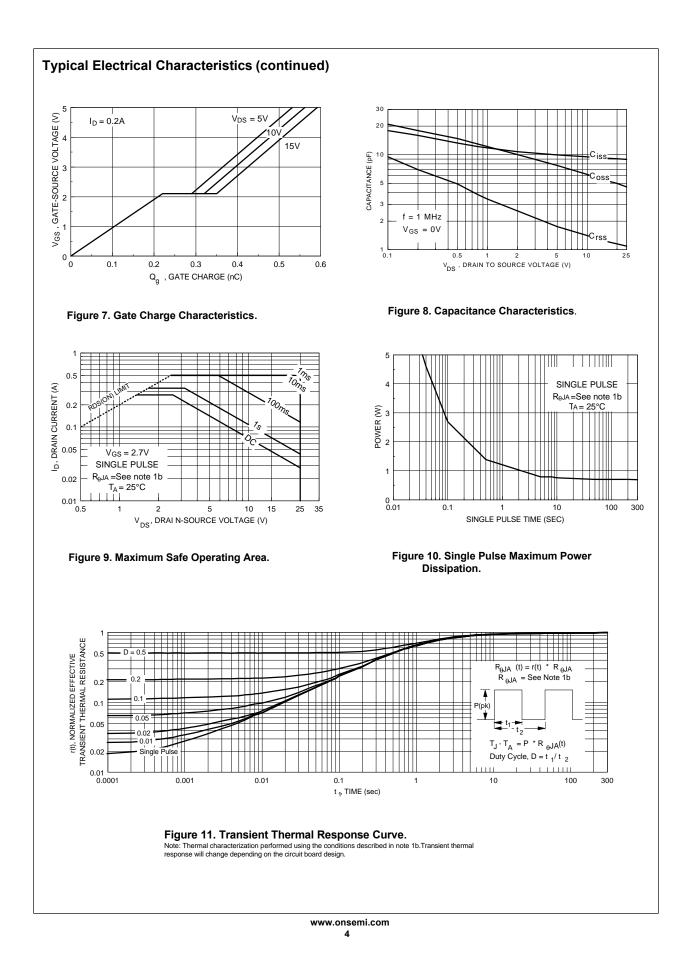


Symbol	Parameter		FDC6301N	Units	
$V_{\rm DSS}, V_{\rm CC}$	Drain-Source Voltage, Power Supply Voltage		25	V	
V_{GSS}, V_{IN}	Gate-Source Voltage, V _{IN}		- 0.5 to +8	V	
I _D , I _{OUT}	Drain/Output Current - Continuous		0.22	A	
	- Pulsed		0.5		
P _D	Maximum Power Dissipation	(Note 1a)	0.9	W	
		(Note 1b)	0.7		
T_,T _{stg}	Operating and Storage Temperature Range		-55 to 150	°C	
ESD	Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm)		6.0	kV	
THERMA	L CHARACTERISTICS	·			
R _{eja}	Thermal Resistance, Junction-to-Ambier	nt (Note 1a)	140	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	60	°C/W	

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OFF CHARA BV _{DSS}	Parameter	Conditions		Min	Тур	Max	Units
BV _{DSS}	ACTERISTICS						
	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		25			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temp. Coefficient	$I_p = 250 \ \mu\text{A}$, Referenced to 25°C			25		mV /°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
200			T ₁ = 55°C			10	μA
GSS	Gate - Body Leakage Current	$V_{GS} = 8 V, V_{DS} = 0 V$	5			100	nA
	CTERISTICS (Note 2)	00 50		1		1	1
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp.Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C			-2.1		mV /°0
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu {\rm A}$		0.65	0.85	1.5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 2.7 \text{ V}, I_D = 0.2 \text{ A}$ $T_{J} = 125^{\circ}\text{C}$			3.8	5	Ω
20(01)					6.3	9	- 22
		$V_{GS} = 4.5 \text{ V}, I_{D} = 0.4 \text{ A}$	3		3.1	4	-
I _{D(ON)}	On-State Drain Current	$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$		0.2			Α
g _{FS}	Forward Transconductance	$V_{\rm DS} = 5 \text{ V}, \ \text{I}_{\rm D} = 0.4 \text{ A}$			0.25		S
	HARACTERISTICS			1		I	ł
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			9.5		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			6		pF
C _{rss}	Reverse Transfer Capacitance				1.3		pF
	CHARACTERISTICS (Note 2)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 6 \text{ V}, \text{ I}_{D} = 0.5 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$			5	10	ns
t,	Turn - On Rise Time				4.5	10	ns
t _{D(off)}	Turn - Off Delay Time				4	8	ns
t _r	Turn - Off Fall Time				3.2	7	ns
Q _g	Total Gate Charge	$V_{DS} = 5 V, I_{D} = 0.2 A,$ $V_{GS} = 4.5 V$			0.49	0.7	nC
Q _{gs}	Gate-Source Charge				0.22		nC
Q_{gd}	Gate-Drain Charge				0.07		nC
Inverter	Electrical Characteristics (T	$_{A} = 25^{\circ}$ C unless other	wise noted)				
O (off)	Zero Input Voltage Output Current	$V_{cc} = 20 \text{ V}, \text{ V}_{l} = 0 \text{ V}$				1	μA
V _{I (off)}	Input Voltage	$V_{cc} = 5 V, I_{o} = 10 \mu A$				0.5	V
V _{I (on)}		$V_0 = 0.3 \text{ V}, I_0 = 0.005 \text{ A}$		1			V
R _{O (on)}	Output to Ground Resistance	$V_1 = 2.7 \text{ V}, \ I_0 = 0.2 \text{ A}$			3.8	5	Ω





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